

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CONTROL CHIP WITH MUTLIPLE-LAYER DEFER QUEUE

th	e specification of whic	h						
	is attached hereto. was filed on as Application Ser		and was amended on_					
ap for	ecification, including to a cknowledge the optication in accordance I hereby claim fore optication(s) for paten	the claims, as amended to duty to disclose info to with Title 37, Code of tign priority benefits un tor inventor's certific atent or inventor's cert med:	and understand the content of by any amendment referred remation which is material to of Federal Regulations, § 1. Idea of Title 35, United States Content and have ificate having a filing date be	ed to above. the patent 56(a). Code, § 119 also identif	ability of this of any foreign			
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No			
90127631		Taiwan, R.O.C.	n, R.O.C. 2001/11/7					
tra	nsact all business in t		6)					
	SEND CORRESPON	NDENCE TO:	DIRECT TELEPHONE CALLS TO: (Name and telephone number)					
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COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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